



CCT4 test results: an update

M. Marchevsky

D. Arbelaez, L. Brower, S, Caspi, E. Hershkovitz, M. Tunio, M. Turqueti, W. Wang, S. Gourlay, S. Prestemon

LBNL



CCT4 test timeline





- Initial cooldown was started on Jul 22, magnet was cooled to 4.2 K
- Compressor malfunction lead to a warmup to ~ 170 K
- Second cooldown to 4.2 K was started on Aug 6, two weeks of testing
- Lost most of the Vtaps in the IL (Kapton trace soldered to cable)
- Lost 1 acoustic sensor (S4, nearest to the He transfer tube)
- Training
- Heater (MQE) tests
- Ramp-rate quenches at 30-200 A/s
- Forced extractions at various current levels up to 13 kA
- Magnetic measurements (z-scan and stair-step cycle)







Acoustic sensors and DAQs





- In-house developed amplified cryogenic sensors
- Built-in GaAs MOSFET amplifiers have 300-1.9 K operational range
- Bandwidth up to ~300 kHz





Continuous streaming at 1 MHz, 4 ch Precise axial localization and timefrequency analysis



Continuous streaming at 40 kHz, 32 ch



Triggered acquisition at 1 MHz, 16 ch Axial / angular quench localization





Continuousortriggered acquisition0.5 – 10 MHz, 8 ch."Active"mechanicalintegrity monitoring

Installation of the acoustic instrumentation





U.S. MAGNET DEVELOPMENT PROGRAM







U.S. MAGNET

PROGRAM

- 104 training quenches in total
- 11 quenches in the OL, the rest is IL
- Highest quench current: 16731 A
- Bore dipole field: 9.14 T
- Field at the conductor: 10.32 T
- "Short sample" limit: 19.3 kA (4.5 K)

A remarkable linear trend is observed for the most part of the training, with an abrupt change of slope at ~ 13 kA

First quench in the CCT4







Mechanical memory of the magnet





U.S. MAGNET

DEVELOPMENT PROGRAM



- CCT4 magnet shows mechanical memory in the initial quenches (Kaiser effect)
- However, as training progressed, acoustic emission started to increase gradually towards the quench, and the memory of the previous quench current disappeared

Two distinct regimes of magnet training

U.S. MAGNET

DEVELOPMENT PROGRAM





U.S. MAGNET

PROGRAM

DEVELOPMENT





F (Hz)

Rib vibrations?



Training scenario



Cracks develop ->

Cracks grow and interconnect -> Cracks percolate the structure

Structure is rigid, parts held together by solid interfaces

Deforms mostly elastically upon stress

Structure is weakened, parts held together by solid interfaces and internal friction

Deforms elastically and plastically, slips along the crack interfaces

Structure is semi-rigid, parts held together largely by the internal friction

Deforms primarily via slipstick motion along the interfaces

Axial and azimuthal quench localization

U.S. MAGNET

DEVELOPMENT PROGRAM





Quench locations: beginning of training

U.S. MAGNET

DEVELOPMENT PROGRAM





Quench locations in the IL: beginning of training

U.S. MAGNET DEVELOPMENT PROGRAM







All IL quench locations





U.S. MAGNET DEVELOPMENT PROGRAM



Quench #

All OL quench locations





U.S. MAGNET DEVELOPMENT PROGRAM



Quench #



ANSYS simulation of transient deformation in the CCT mandrel upon pulsing a piezo-transducer

U.S. MAGNET

DEVELOPMENT PROGRAM



- Coil is pulsed using a piezotransducer, and resulting perturbation is recorded by sensors distributed along the magnet
- The ring-down deformation x(t) at any location is <u>uniquely defined</u> by the magnet geometry, Young's moduli of the materials, and their mutual interfaces
- Acoustic wave reverberates multiple times thus allowing to detect structural perturbation anywhere in the magnet
- Technique is non-invasive, and be adapted to existing magnet systems

Pulse propagation in the CCT4 magnet



Transducer is mounted on the inner layer mandrel; powered with a 100 V / 14 μ s rectangular pulse at 1-10 Hz repetition rate

U.S. MAGNET

DEVELOPMEN1 PROGRAM



Pulse propagation: S9 -> (S2 S4 S6) -> (S3 S2 S7) -> S8



0.5 ms window is set individually for each waveform, and then periodically monitored with each pulse



Locating variation of the mechanical contacts



Transmitted pulse amplitude



As magnet deforms under stress, sensors <u>S2 and S3 are seeing an</u> <u>improving mechanical contact</u> between shell and inner / outer layers, while S1 is seeing a loss of mechanical contact.



Time shift is found by cross-correlating the initial "reference" waveforms with the consecutive ones.

Same principle as in:. M. Marchevsky and S.A. Gourlay, Appl. Phys. Lett. 110, 2017 doi:10.1063/1.4973466



Temperature monitoring inside the coil



A thermometer of ~1 mm² size was installed directly in the cable groove, in the magnet outer layer, prior to impregnation

U.S. MAGNET

PROGRAM

DEVELOPMENT



Pole location

Thermometer was powered by 10 μ A bias current and monitored simultaneously with acoustic signal and coil voltages during ramps.

Thermal and acoustic spikes are correlated





~ 36.5 s

U.S. MAGNET

PROGRAM

- Temperature spikes as high as 1 K are observed in the "cracking" regime. All of them are time-correlated with the acoustic events, and few also correlate with voltage spikes on the coils
- A minor (< 20 mK) gradual temperature rise, or none at all is seen in the "slip-stick" regime prior to quenching

Minimal quench energy measurements



Spot heater was fired periodically for 400 ms at 3 s intervals, gradually increasing the power.

U.S. MAGNET

PROGRAM

DEVELOPMENT







We can now cross-check MQE and thermal data against the crack-induced heating, and compare with the temperature margin I_{cs} (B,T)





- Two distinctly different slopes of CCT4 training curve can be tentatively identified as ones dominated by epoxy cracking and slip-stick motion respectively
- Active acoustic monitoring identifies locations of intermittent mechanical contact within magnet structure
- Thermal spikes associated with epoxy cracking were observed
- MQE has been measured

Work in progress on analyzing high-frequency acoustic data for event type sorting according to their associated disturbance spectra and deposited energy,. We also work on correlating thermal and acoustic measurements with models to understand impact of cracking and slipstick to quench performance limitation.